# Chip resistor networks MNR04 (1005 × 4 size)

#### Features

1) Extremely small and light

Area ratio is 60% smaller than that of chip 1632 (MNR14), while weight ratio has been cut 75%.

2) High-density mounting

Can be mounted even more densely than four 1005 chips (MCR01), and mounting costs are lower.

- 3) Can be mounted on a wide variety of devices
  - Squared comers make it excellent for mounting on image recognition devices.
- 4) Convex electrodes

Easy to check the fillet after soldering is finished.

5) ROHM resistors comply with the international standard ISO-9001.

Furthermore, changes to the design and specifications of products may occur without notice. Therefore, before ordering or using this product, please make sure to reconfirm the specification sheet before ordering or using this product.

### Ratings

Item	Conditions	Specifications	
Rated power	Power must be derated according to the power derating curve in Figure 1 when ambient temperature exceeds 70°C.  **B0	0.031W (1 / 32W) at 70°C	
Rated voltage	value obtained exceeds the maximum operating voltage, the	Max. operating voltage	25V
	voltage rating is equal to maximum operating voltage.  E: Voltage rating (V)	Max. overload voltage	50V
	$E = \sqrt{P \times R}$ P : Power rating (W) R : Nominal resistance (Ω)	Max. intermittent overload voltage	50V
Nominal resistance	See <u>Table 1</u> .		
Operating temperature		- 55°C to + 125°C	



Jumper type			
Resistance	Max.50mΩ		
Rated current	1A		
Peak current	2A		
Operating temperature	- 55°C to + 125°C		

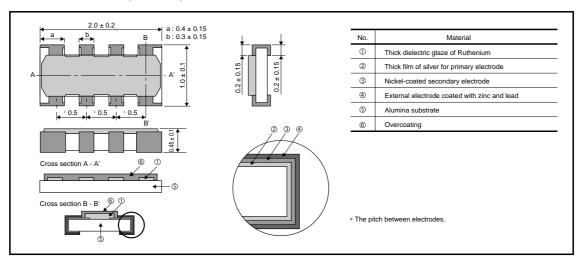
Table 1			
Resistance range $(\Omega)$	Resistance temperature coefficient (ppm / °C)		
10 ≤ R ≤ 1M (E24)	± 300		
	(Ω)		

<sup>•</sup>Before using components in circuits where they will be exposed to transients such as pulse loads (short-duration, high-level loads), be certain to evaluate the component in the mounted state. In addition, the reliability and performance of this component cannot be guaranteed if it is used with a steady state voltage that is greater than its rated voltage.

#### Characteristics

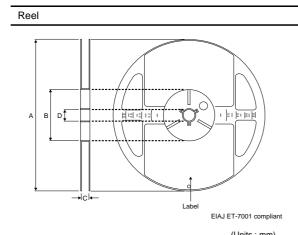
Characteristics	Specifications	Test method (JIS C 5202)	
DC resistance	J: ±5%	JIS C 5202 5.1 Applied voltage : A	
Resistance temperature characteristics	See Table 1	JIS C 5202 5.2 Test conditions: + 25 / - 55 / + 25 / + 125	
Short time overload	± (5.0% + 0.1Ω)	JIS C 5202 5.5 Rated voltage (current) × 2.5, 5s Maximum overload voltage : 50V	
Resistance to soldering heat	$\pm$ (2.5% + 0.1 $\Omega$ )  Outside must not be noticeably damaged.	JIS C 5202 6.4 Soldering conditions : 260 ± 5°C Soldering time : 10 ± 1s.	
Solderability	95% of terminal surface must be covered by new soldering, and there must be no soldering corrosion.	JIS C 5202 6.5 Rosin methanol : (25%WT) Soldering conditions : 235 ± 5°C Soldering time : 2 ± 0.5s.	
Resistance to dry heat	± (5.0% + 0.1Ω)	JIS C 5202 7.2 125°C Test time : 1,000 to 1,048 hrs.	
Endurance (rated load)	± (5.0% + 0.1Ω)	JIS C 5202 7.10 Rated voltage (current), 70°C 1.5h: ON - 0.5h: OFF Test time: 1,000 to 1,048 hrs.	
Endurance (under load in damp environment)	± (5.0% + 0.1Ω)	JIS C 5202 7.9 Rated voltage (current) , 60°C, 95%RH 1.5h : ON - 0.5h : OFF Test time : 1,000 to 1,048 hrs.	
Resistance to humidity (steady state)	± (5.0% + 0.1Ω)	JIS C 5202 7.5 85°C, 85%RH Test time : 1,000 to 1,048 hrs.	
Temperature cycling	± (2.5% + 0.1Ω)	JIS C 5202 7.4 Test temperature : - 55°C to + 125°C 100cyc.	
Resistance to solvents	± (1.0% + 0.05Ω)	JIS C 5202 6.9 Room temperature, static immersion, 1 min. Solvent : Isopropyl alcohol	

### ●External dimensions (Units: mm)

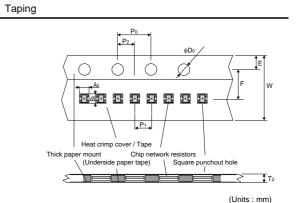


# ●Equivalent circuit

## Packaging



				(Offics : Iffiff)
А		В	С	D
	φ180 0 - 3	φ60 + 1 0	9 ± 0.3	φ13 ± 0.2



				(Offits : Iffiff)
W	F	Е	A <sub>0</sub>	Bo
8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	1.2 ± 0.1	2.2 ± 0.1
D <sub>0</sub>	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	T <sub>2</sub>
φ1.5 + 0.1 0	4.0 ± 0.1	2.0 ± 0.1	2.0 ± 0.05	Max. 0.5

## Product designation

